μ PG2417T6M

Data Sheet

GaAs Integrated Circuit SP6T Switch for NFC Application

R09DS0010EJ0100 Rev.1.00 Dec 24, 2010

DESCRIPTION

The μ PG2417T6M is a GaAs MMIC for SP6T (<u>Single Pole Six Throw</u>) switch for NFC (<u>Near Field Communication</u>) application.

This device is housed in a 12-pin plastic TSQFN (<u>Thin Small Quad Flat Non-leaded</u>) (T6M) package and is suitable for high-density surface mounting.

FEATURES

• 1, 2, 4, 8 pF capacitors on RF path are built in PKG.

• Switch control voltage : $V_{cont (H)} = 2.85 \text{ V TYP}.$

: $V_{\text{cont (L)}} = 0 \text{ V TYP}$.

Low insertion loss
 L_{ins} = 0.5 dB TYP. @ f = 13.56 MHz
 High isolation
 ISL = 50 dB TYP. @ f = 13.56 MHz

• Handling power : $P_{in (0.1 \text{ dB})} = +32.0 \text{ dBm TYP.}$ @ f = 13.56 MHz

• High-density surface mounting: 12-pin plastic TSQFN (T6M) package $(2.0 \times 2.0 \times 0.37 \text{ mm})$

APPLICATIONS

• NFC Application (FeliCaTM etc.)

ORDERING INFORMATION

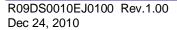
Part Number	Order Number	Package	Marking	Supplying Form
μPG2417T6M-E2	μPG2417T6M-E2-A	12-pin plastic TSQFN	2417	Embossed tape 8 mm wide
		(T6M) (Pb-Free)		Pin 10, 11, 12 face the perforation
				side of the tape
				 Qty 3 kpcs/reel

Remark To order evaluation samples, please contact your nearby sales office.

Part number for sample order: µPG2417T6M-A

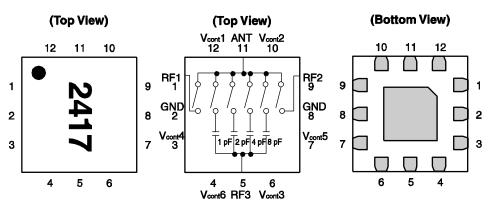
CAUTION

Although this device is designed to be as robust as possible, ESD (Electrostatic Discharge) can damage this device. This device must be protected at all times from ESD. Static charges may easily produce potentials of several kilovolts on the human body or equipment, which can discharge without detection. Industry-standard ESD precautions must be employed at all times.





PIN CONNECTIONS AND INTERNAL BLOCK DIAGRAM



Pin No.	Pin Name
1	RF1
2	GND
3	$V_{cont}4$
4	$V_{cont}6$
5	RF3
6	V _{cont} 3
7	$V_{cont}5$
8	GND
9	RF2
10	V _{cont} 2
11	ANT
12	V _{cont} 1

SW TRUTH TABLE

	RF Path	,		ı				
ANT-RF3 Capacitor)	ANT-RF1	ANT-RF2	V _{cont} 1	V _{cont} 2	V _{cont} 3	V _{cont} 4	V _{cont} 5	V _{cont} 6
Capacitor	OFF	ON	L	Н	L	L	L	L
OFF	ON	OFF	Н	L	L	L	L	L
	ON	ON	Н	Н	L	L	L	L
	OFF	OFF	L	L	Н	L	L	L
	OFF	ON	L	Н	Н	L	L	L
1 pF	ON	OFF	Н	L	Н	L	L	4
	ON	ON	Н	Н	Н	L	L	L
	OFF	OFF	L	L	L	Н	L	L
	OFF	ON	L	Н	L	Н	L	L
2 pF	ON	OFF	Н	L	L	Н	L	L
	ON	ON	Н	Н	L	Н	L	L
	OFF	OFF	L	L	Н	Н	L	L
3 pF	OFF	ON	L	Н	Н	Н	1	L
з рг	ON	OFF	Н	L	Н	Н	L	L
	ON	ON	Н	Н	Н	Н	L	L
	OFF	OFF	L	L	L	L	Н	L
4 pF	OFF	ON	L	Н	L		Н	L
- γı	ON	OFF	Н	L	L	L	Н	L
	ON	ON	Н	Н	L	L	Н	L
	OFF	OFF	L	L	Н	L	Н	L
5 pF	OFF	ON	L	Н	Н	L	Н	L
υрг	ON	OFF	Н	L	Н	L	Н	L
	ON	ON	Н	Н	H	L	Н	L
	OFF	OFF	L	L	L	Н	Н	L
6 pF -	OFF	ON	L	Н	L	Н	Н	L
	ON	OFF	Н	L	L	Н	Н	L
	ON	ON	Н	Н	L	Н	Н	L
7 pF	OFF	OFF	L	L	Н	Н	Н	L
	OFF	ON	L	Н	Н	Н	Н	L
	ON	OFF	Н	L	Н	Н	Н	L
	ON	ON	Н	Н	Н	Н	Н	L
8 pF	OFF	OFF	L	L	L	L	L	Н
	OFF	ON	L	H	L	L	L	Н
	ON	OFF	Н	L	L	L	L	Н
	ON	ON	Н	Н	L	L	L	Н
9 pF	OFF	OFF	L	L	Н	L	L	Н
	OFF	ON	L	Н	Н	L	L	Н
о р.	ON	OFF	Н	L	Н	L	L	Н
	ON	ON	Н	Н	Н	L	L	Н
	OFF	OFF	L	L	L	Н	L	Н
10 pF	OFF	ON	L	Н	L	Н	L	Н
٠- ۳٠	ON	OFF	Н	L	L	Н	L	Н
	ON	ON	Н	Н	L	Н	L	Н
	OFF	OFF	L	L	Н	Н	L	Н
11 pF	OFF	ON	L	H	Н	Н	L	H
	ON	OFF	H	L	Н	Н	L	Н
	ON	ON	H	Н	H	H	L	Н
	OFF	OFF	<u>L</u>	L	L .	L .	Н	H
12 pF	OFF	ON	L	H	L .	L .	Н	H
	ON	OFF	H	L	L	L	Н	Н
	ON	ON	H	Н	L	L	Н	Н
	OFF	OFF	L .	L	H	L	Н	Н
13 pF	OFF	ON	L	H	H	L	Н	H
	ON	OFF	H	L	H	L	Н	Н
	ON	ON	H	Н	H	L	Н	Н
	OFF	OFF	<u>L</u>	L	L	Н	Н	H
14 pF	OFF	ON	L	H	L	Н	Н	Н
	ON	OFF	H	L	L	Н	Н	H
	ON	ON	H	Н	L	Н	Н	Н
	OFF	OFF	L	L	Н	Н	Н	Н
15 pF	OFF	ON	L	Н	Н	Н	Н	Н
10 βι	ON	OFF	Н	L	Н	Н	Н	Н

ABSOLUTE MAXIMUM RATINGS (T_A = +25°C, unless otherwise specified)

Parameter	Symbol	Ratings	Unit
Switch Control Voltage	V_{cont}	-6.0 to +6.0 Note	V
Input Power (ON Port)	Pin	+35.0	dBm
Operating Ambient Temperature	T _A	-45 to +85	°C
Storage Temperature	T _{stq}	-55 to +150	°C

Note: $\left|V_{cont (H)} - V_{cont}\right|$ (L) $\leq 6.0 \text{ V}$

RECOMMENDED OPERATING RANGE (TA = +25°C, unless otherwise specified)

Parameter	Symbol	MIN.	TYP.	MAX.	Unit
Switch Control Voltage (H)	V _{cont (H)}	+2.4	+2.85	+3.4	>
Switch Control Voltage (L)	V _{cont (L)}	-0.2	0	+0.2	V
Control Voltage Difference	∠V _{cont (H)} ,	-0.1	0	+0.1	V
	△V _{cont (L)} Note				

Note: $extstyle V_{\text{CONT(H)}}$ is a difference between the maximum and the minimum control voltage among $V_{\text{CONT}1_{(H)}}$, $V_{\text{CONT}2_{(H)}}$, $V_{\text{CONT}4_{(H)}}$, $V_{\text{CONT}5_{(H)}}$ and $V_{\text{CONT}6_{(H)}}$.

 \angle V_{CONT}(L) is a difference between the maximum and the minimum control voltage among V_{CONT}1_(L), V_{CONT}2_(L), V_{CONT}3_(L), V_{CONT}4_(L), V_{CONT}5_(L) and V_{CONT}6_(L).





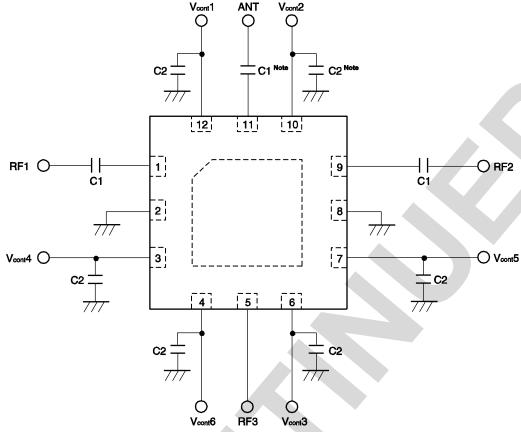
ELECTRICAL CHARACTERISTICS (T_A = -45 to +85°C, f = 13.56 MHz, $V_{cont \, (H)}$ = +2.4 to +3.4V, $V_{cont \, (L)}$ = -0.2 to +0.2 V, Z_O = 50 Ω , DC blocking capacitors = 10 000 pF, unless otherwise specified)

Parameter	Symbol	Test Conditions	MIN.	TYP.	MAX.	Unit
Insertion Loss	L _{ins} 1	ANT-RF1, $V_{cont}1 = H$, $P_{in} = +20 \text{ dBm}$	_	0.5	0.9	dB
	L _{ins} 2	ANT-RF2, $V_{cont}2 = H$, $P_{in} = +20 \text{ dBm}$	_	0.5	0.9	dB
	L _{ins} 3	ANT-RF3, $V_{cont}3 = H$, $P_{in} = +20 \text{ dBm}$	36.0	38.0	40.0	dB
	L _{ins} 4	ANT-RF3, $V_{cont}4 = H$, $P_{in} = +20 \text{ dBm}$	31.5	33.5	35.5	dB
	L _{ins} 5	ANT-RF3, $V_{cont}5 = H$, $P_{in} = +20 \text{ dBm}$	26.0	28.0	30.0	dB
	L _{ins} 6	ANT-RF3, $V_{cont}6 = H$, $P_{in} = +20 \text{ dBm}$	20.5	22.5	24.5	dB
Isolation	ISL1	ANT-RF1, $V_{cont}2 = H$, $P_{in} = +20 \text{ dBm}$	32.0	50.0	-	dB
	ISL2	ANT-RF2, $V_{cont}1 = H$, $P_{in} = +20 \text{ dBm}$	32.0	50.0	-	dB
Capacitance Value	Cap 1	ANT-RF3, V _{cont} 3 = H	_	1.0	-7	pF
	Cap 2	ANT-RF3, $V_{cont}4 = H$	-	2.0	/-	pF
	Cap 3	ANT-RF3, V _{cont} 5 = H	-	4.0	_	pF
	Cap 4	ANT-RF3, V _{cont} 6 = H	-	8.0	-	pF
0.1 dB Loss Compression	P _{in (0.1 dB)}	ANT-RF1/RF2	28.0	32.0	-	dBm
Input Power Note						
Switch Control Current	I _{cont}	No RF input	-	2	30	μA
Switch Control Speed	tsw	50% CTL to 90/10% RF	-	1	5	μS

P_{in (0.1 dB)} is the measured input power level when the insertion loss increases 0.1 dB more than that of the linear Note: range.



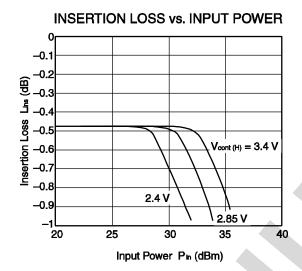
EVALUATION CIRCUIT



Note: C1: 10 000 pF C2: 10 000 pF

The application circuits and their parameters are for reference only and are not intended for use in actual design-ins.

TYPICAL CHARACTERISTICS (T_A = +25°C, f = 13.56 MHz, V_{cont (H)} = +2.4 to +3.4 V, V_{cont (L)} = 0 V, Z_O = 50 Ω , DC blocking capacitors = 10 000 pF)

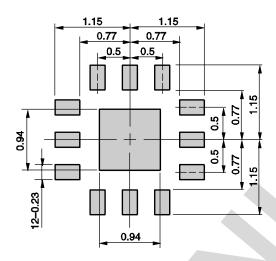


Remark The graph indicates nominal characteristics.

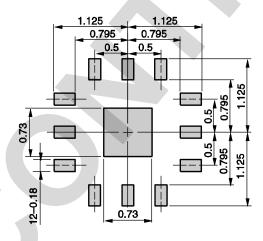
MOUNTING PAD AND SOLDER MASK LAYOUT DIMENSIONS

12-PIN PLASTIC TSQFN (T6M) (UNIT: mm)

MOUNTING PAD



SOLDER MASK

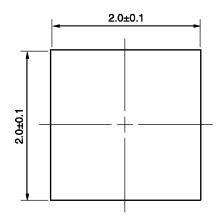


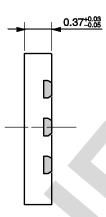
Solder thickness: 0.1 mm

Remark The mounting pad and solder mask layouts in this document are for reference only.

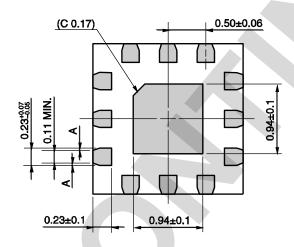
PACKAGE DIMENSIONS

12-PIN PLASTIC TSQFN (T6M) (UNIT: mm)





(Bottom View)



Remark A > 0

(): Reference value

RECOMMENDED SOLDERING CONDITIONS

This product should be soldered and mounted under the following recommended conditions. For soldering methods and conditions other than those recommended below, contact your nearby sales office.

Soldering Method	Soldering Conditions		Condition Symbol
Infrared Reflow	Peak temperature (package surface temperature)	: 260°C or below	IR260
	Time at peak temperature	: 10 seconds or less	
	Time at temperature of 220°C or higher	: 60 seconds or less	
	Preheating time at 120 to 180°C	: 120±30 seconds	
	Maximum number of reflow processes	: 3 times	
	Maximum chlorine content of rosin flux (% mass)	: 0.2%(Wt.) or below	
Partial Heating	Peak temperature (terminal temperature)	: 350°C or below	HS350
	Soldering time (per side of device)	: 3 seconds or less	
	Maximum chlorine content of rosin flux (% mass)	: 0.2%(Wt.) or below	

CAUTION

Do not use different soldering methods together (except for partial heating).



Caution

GaAs Products

This product uses gallium arsenide (GaAs).

GaAs vapor and powder are hazardous to human health if inhaled or ingested, so please observe the following points.

- Follow related laws and ordinances when disposing of the product. If there are no applicable laws and/or ordinances, dispose of the product as recommended below.
- 1. Commission a disposal company able to (with a license to) collect, transport and dispose of materials that contain arsenic and other such industrial waste materials.
- 2. Exclude the product from general industrial waste and household garbage, and ensure that the product is controlled (as industrial waste subject to special control) up until final disposal.
- Do not burn, destroy, cut, crush, or chemically dissolve the product.
- Do not lick the product or in any way allow it to enter the mouth.



Revision History

μ PG2417T6M Data Sheet

		Description	
Rev.	Date	Page Summary	
1.00	Dec 24, 2010	_	First edition issued



FeliCa is the contactless IC card technology developed by Sony Corporation.

FeliCa is a trademark of Sony Corporation.

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